

# 74LVC16244A-Q100; 74LVCH16244A-Q100 16-bit buffer/line driver; 5 V input/output tolerant; 3-state

Product data sheet

## 1. General description

The 74LVC16244A-Q100; 74LVCH16244A-Q100 is a 16-bit buffer/line driver with 3-state outputs. The device can be used as four 4-bit buffers, two 8-bit buffers or one 16-bit buffer. The device features four output enables (1OE, 2OE, 3OE and 4OE), each controlling four of the 3-state outputs. A HIGH on nOE causes the outputs to assume a high-impedance OFF-state. Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environments. Schmitt-trigger action at all inputs makes the circuit tolerant of slower input rise and fall times. This device is fully specified for partial power down applications using I<sub>OFF</sub>. The I<sub>OFF</sub> circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

The 74LVCH16244A-Q100 bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

#### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 1.2 V to 3.6 V
- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- CMOS low power consumption
- Multibyte flow-through standard pin-out architecture
- Low inductance multiple power and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels
- High-impedance when  $V_{CC} = 0 \text{ V}$
- All data inputs have bus hold. (74LVCH16244A-Q100 only)
- Complies with JEDEC standard:
  - JESD8-7A (1.65 V to 1.95 V)
  - JESD8-5A (2.3 V to 2.7 V)
  - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V

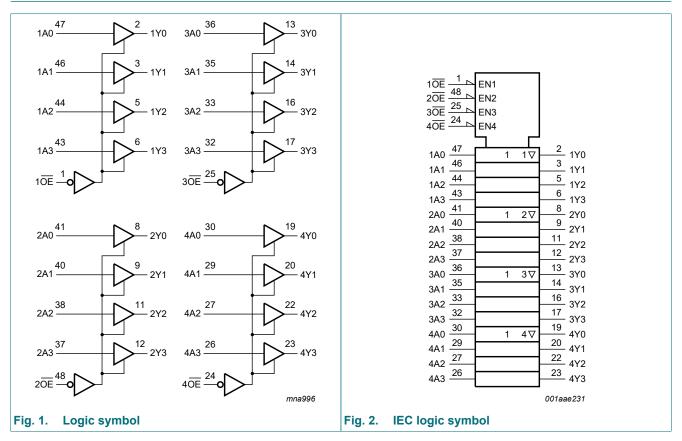


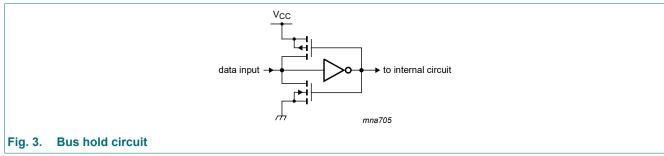
## 3. Ordering information

**Table 1. Ordering information** 

Type number	Temperature range	Package					
		Name	Description	Version			
74LVC16244ADGG-Q100 74LVCH16244ADGG-Q100	-40 °C to +125 °C	TSSOP48	plastic thin shrink small outline package; 48 leads; body width 6.1 mm	SOT362-1			
74LVC16244ADGV-Q100 74LVCH16244ADGV-Q100	-40 °C to +125 °C	TVSOP48	plastic thin shrink small outline package; 48 leads; body width 4.4 mm; lead pitch 0.4 mm	SOT480-1			

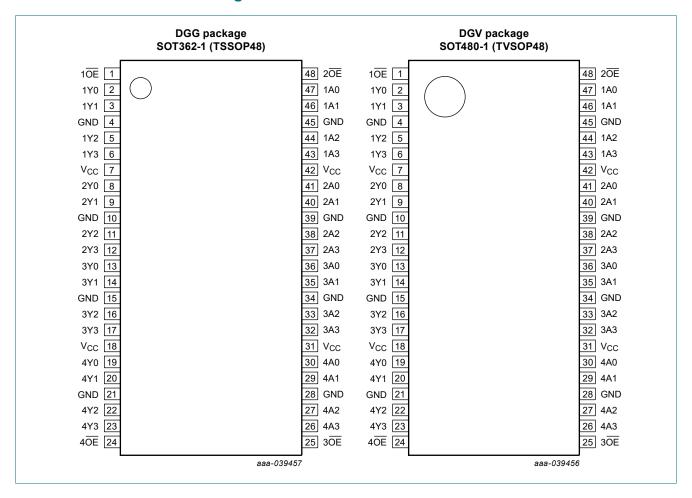
## 4. Functional diagram





## 5. Pinning information

#### 5.1. Pinning



#### 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description	
1 <del>OE</del> , 2 <del>OE</del> , 3 <del>OE</del> , 4 <del>OE</del>	1, 48, 25, 24	output enable input (active LOW)	
1Y0 to 1Y3	2, 3, 5, 6	data output	
2Y0 to 2Y3	8, 9, 11, 12	data output	
3Y0 to 3Y3	13, 14, 16, 17	data output	
4Y0 to 4Y3	19, 20, 22, 23	data output	
GND	4, 10, 15, 21, 28, 34, 39, 45	ground (0 V)	
V <sub>CC</sub>	7, 18, 31, 42	supply voltage	
1A0 to 1A3	47, 46, 44, 43	data input	
2A0 to 2A3	41, 40, 38, 37	data input	
3A0 to 3A3	36, 35, 33, 32	data input	
4A0 to 4A3	30, 29, 27, 26	data input	

## 6. Functional description

#### **Table 3. Function table**

 $H = HIGH \text{ voltage level}; L = LOW \text{ voltage level}; X = don't care; Z = high-impedance OFF-state.}$ 

	Input	Output
nŌE	nAn	nYn
L	L	L
L	Н	Н
Н	X	Z

## 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
VI	input voltage	[1]	-0.5	+6.5	V
I <sub>OK</sub>	output clamping current	$V_O > V_{CC}$ or $V_O < 0$ V	-	±50	mA
Vo	output voltage	output HIGH or LOW [2]	-0.5	V <sub>CC</sub> + 0.5	V
		output 3-state [2]	-0.5	+6.5	V
Io	output current	V <sub>O</sub> = 0 V to V <sub>CC</sub>	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
$I_{GND}$	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C};$ [3]	-	500	mW

<sup>[1]</sup> The minimum input voltage ratings may be exceeded if the input current ratings are observed.

## 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage		1.65	-	3.6	V
		functional	1.2	-	3.6	V
VI	input voltage		0	-	5.5	V
V <sub>O</sub>	output voltage	output HIGH or LOW	0	-	V <sub>CC</sub>	V
		output 3-state	0	-	5.5	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 1.2 V to 2.7 V	0	-	20	ns/V
		$V_{CC}$ = 2.7 V to 3.6 V	0	-	10	ns/V

<sup>[2]</sup> The output voltage ratings may be exceeded if the output current ratings are observed.

<sup>[3]</sup> For SOT362-1 (TSSOP48) packages: P<sub>tot</sub> derates linearly with 12.2 mW/K above 109 °C. For SOT480-1 (TVSOP48) packages: P<sub>tot</sub> derates linearly with 5.5 mW/K above 60 °C.

## 9. Static characteristics

**Table 6. Static characteristics** 

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max		
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 1.2 V		1.08	-	-	1.08	-	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V		0.65V <sub>CC</sub>	-	-	0.65V <sub>CC</sub>	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V		1.7	-	-	1.7	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V		2.0	-	-	2.0	-	V
V <sub>IL</sub>	LOW-level input	V <sub>CC</sub> = 1.2 V		-	-	0.12	-	0.12	V
	voltage	V <sub>CC</sub> = 1.65 V to 1.95 V		-	-	0.35V <sub>CC</sub>	-	0.35V <sub>CC</sub>	V
		V <sub>CC</sub> = 2.3 V to 2.7 V		-	-	0.7	-	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V		-	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>							
	output voltage	I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V		V <sub>CC</sub> -0.2	-	-	V <sub>CC</sub> -0.3	-	V
		I <sub>O</sub> = -4 mA; V <sub>CC</sub> = 1.65 V		1.2	-	-	1.05	-	V
		I <sub>O</sub> = -8 mA; V <sub>CC</sub> = 2.3 V		1.8	-	-	1.65	-	V
		I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V		2.2	-	-	2.05	-	V
		I <sub>O</sub> = -18 mA; V <sub>CC</sub> = 3.0 V		2.4	-	-	2.25	-	V
		I <sub>O</sub> = -24 mA; V <sub>CC</sub> = 3.0 V		2.2	-	-	2.0	-	V
V <sub>OL</sub>	LOW-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>							
	output voltage	I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V		-	-	0.2	-	0.3	V
		I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V		-	-	0.45	-	0.65	V
		I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V		-	-	0.6	-	0.8	V
		I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V		-	-	0.4	-	0.6	V
		I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V		-	-	0.55	-	0.8	V
I <sub>I</sub>	input leakage current	$V_{CC} = 3.6 \text{ V}; V_{I} = 5.5 \text{ V or GND}$		-	±0.1	±5	-	±20	μΑ
l <sub>OZ</sub>	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \text{ V}; V_{O} = 5.5 \text{ V or GND}$	[2]	-	±0.1	±5	-	±20	μΑ
I <sub>OFF</sub>	power-off leakage current	$V_{CC} = 0 \text{ V; } V_{I} \text{ or } V_{O} = 5.5 \text{ V}$		-	±0.1	±10	-	±20	μΑ
I <sub>CC</sub>	supply current	$V_{CC} = 3.6 \text{ V; } I_{O} = 0 \text{ A;}$ $V_{I} = V_{CC} \text{ or GND}$		-	0.1	20	-	80	μΑ
ΔI <sub>CC</sub>	additional supply current	per input pin; V <sub>CC</sub> = 2.7 V to 3.6 V; V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0 A		-	5	500	-	5000	μΑ
Cı	input capacitance	$V_{CC}$ = 0 V to 3.6 V; V <sub>I</sub> = GND to $V_{CC}$		-	5.0	-	-	-	pF
I <sub>BHL</sub>	bus hold LOW	V <sub>CC</sub> = 1.65; V <sub>I</sub> = 0.58 V	[3][4]	10	-	-	10	-	μΑ
	current	V <sub>CC</sub> = 2.3; V <sub>I</sub> = 0.7 V		30	-	-	25	-	μA
		V <sub>CC</sub> = 3.0; V <sub>I</sub> = 0.8 V		75	-	-	60	-	μA
I <sub>BHH</sub>	bus hold HIGH	V <sub>CC</sub> = 1.65; V <sub>I</sub> = 1.07 V	[3] [4]	-10	-	-	-10	-	μA
	current	V <sub>CC</sub> = 2.3; V <sub>I</sub> = 1.7 V		-30	-	-	-25	-	μA
		V <sub>CC</sub> = 3.0; V <sub>I</sub> = 2.0 V		-75	_	_	-60	-	μA

Symbol	Parameter	Conditions	-40	°C to +85	5 °C	-40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
I <sub>BHLO</sub>	bus hold LOW	V <sub>CC</sub> = 1.95 V [3] [5]	200	-	-	200	-	μΑ
	overdrive current	V <sub>CC</sub> = 2.7 V	300	-	-	300	-	μΑ
	Carront	V <sub>CC</sub> = 3.6 V	500	-	-	500	-	μΑ
I <sub>BHHO</sub>	bus hold HIGH	V <sub>CC</sub> = 1.95 V [3] [5]	-200	-	-	-200	-	μΑ
	overdrive current	V <sub>CC</sub> = 2.7 V	-300	-	-	-300	-	μΑ
	Carront	V <sub>CC</sub> = 3.6 V	-500	-	-	-500	-	μΑ

- [1] All typical values are measured at  $V_{CC}$  = 3.3 V and  $T_{amb}$  = 25 °C.
- [2] The bus hold circuit is switched off when  $V_I > V_{CC}$  allowing 5.5 V on the input terminal.
- [3] Valid for data inputs only. Control inputs do not have a bus hold circuit.
- [4] The specified sustaining current at the data input holds the input below the specified V<sub>I</sub> level.
- [5] The specified overdrive current at the data input forces the data input to the opposite logic input state.

## 10. Dynamic characteristics

#### **Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit see Fig. 6.

Symbol	Parameter	Conditions	-40	°C to +85	5 °C	-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
t <sub>pd</sub>	propagation	nAn to nYn; see Fig. 4 [2]						
	delay	V <sub>CC</sub> = 1.2 V	-	11.0	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.5	4.8	10.7	1.5	11.3	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	2.6	5.3	1.0	5.9	ns
		V <sub>CC</sub> = 2.7 V	1.0	2.6	4.7	1.0	6.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.1	2.2	4.1	1.1	5.5	ns
t <sub>en</sub>	enable time	nOE to nYn; see Fig. 5 [2]						
		V <sub>CC</sub> = 1.2 V	-	15.0	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.5	6.2	12.1	1.5	12.7	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	3.5	6.4	1.0	7.1	ns
		V <sub>CC</sub> = 2.7 V	1.0	3.3	5.8	1.0	7.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	2.8	4.6	1.0	6.0	ns
t <sub>dis</sub>	disable time	nOE to nYn; see Fig. 5 [2]						
		V <sub>CC</sub> = 1.2 V	-	10.0	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.5	4.4	8.7	2.5	9.4	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	2.4	4.9	1.0	5.3	ns
		V <sub>CC</sub> = 2.7 V	1.0	3.2	6.2	1.0	8.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.8	3.1	5.2	1.8	6.5	ns
C <sub>PD</sub>	power	per input; $V_I = GND$ to $V_{CC}$ [3]						
	dissipation capacitance	V <sub>CC</sub> = 1.65 V to 1.95 V	-	4.8	-	-	-	pF
	- Sapasitarioe	V <sub>CC</sub> = 2.3 V to 2.7 V	-	8.3	-	-	-	pF
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	11.4	-	-	-	pF

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

74LVC\_LVCH16244A\_Q100

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<sup>[2]</sup>  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ ;  $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ ;  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .

<sup>[3]</sup> C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW). P<sub>D</sub> = C<sub>PD</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>i</sub> × N + ∑(C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) where: f<sub>i</sub> = input frequency in MHz; f<sub>o</sub> = output frequency in MHz; C<sub>L</sub> = output load capacitance in pF V<sub>CC</sub> = supply voltage in Volts; N = number of inputs switching; ∑(C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) = sum of the outputs.

#### 10.1. Waveforms and test circuit

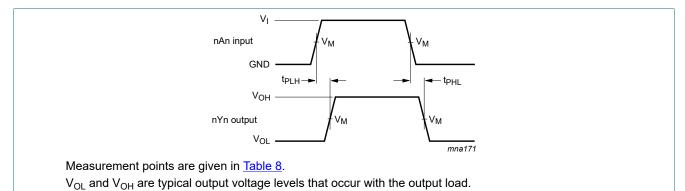
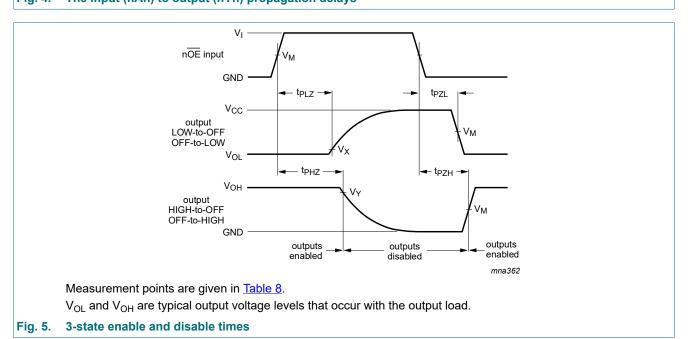
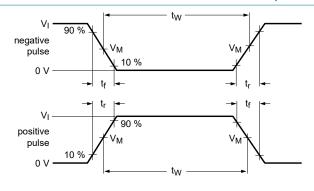


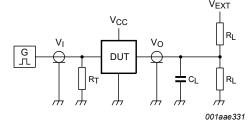
Fig. 4. The input (nAn) to output (nYn) propagation delays



**Table 8. Measurement points** 

Supply voltage	Input		Output			
V <sub>CC</sub>	V <sub>M</sub>	VI	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>	
1.2 V	0.5 × V <sub>CC</sub>	V <sub>CC</sub>	0.5 × V <sub>CC</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> - 0.15 V	
1.65 V to 1.95 V	0.5 × V <sub>CC</sub>	V <sub>CC</sub>	0.5 × V <sub>CC</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> - 0.15 V	
2.3 V to 2.7 V	0.5 × V <sub>CC</sub>	V <sub>CC</sub>	0.5 × V <sub>CC</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> - 0.15 V	
2.7 V	1.5 V	2.7 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> - 0.3 V	
3.0 V to 3.6 V	1.5 V	2.7 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> - 0.3 V	





Test data is given in Table 9.

Definitions for test circuit:

 $R_L$  = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

 $V_{\text{EXT}}$  = External voltage for measuring switching times.

Fig. 6. Test circuit for measuring switching times

Table 9. Test data

Supply voltage	Input L		Load		Load		V <sub>EXT</sub>		
	$V_{l}$	t <sub>r</sub> , t <sub>f</sub>	CL	$R_L$	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PHZ</sub> , t <sub>PZH</sub>		
1.2 V	V <sub>CC</sub>	≤ 2 ns	30 pF	1 kΩ	open	2 × V <sub>CC</sub>	GND		
1.65 V to 1.95 V	V <sub>CC</sub>	≤ 2 ns	30 pF	1 kΩ	open	2 × V <sub>CC</sub>	GND		
2.3 V to 2.7 V	V <sub>CC</sub>	≤ 2 ns	30 pF	500 Ω	open	2 × V <sub>CC</sub>	GND		
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	2 × V <sub>CC</sub>	GND		
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	2 × V <sub>CC</sub>	GND		

## 11. Package outline

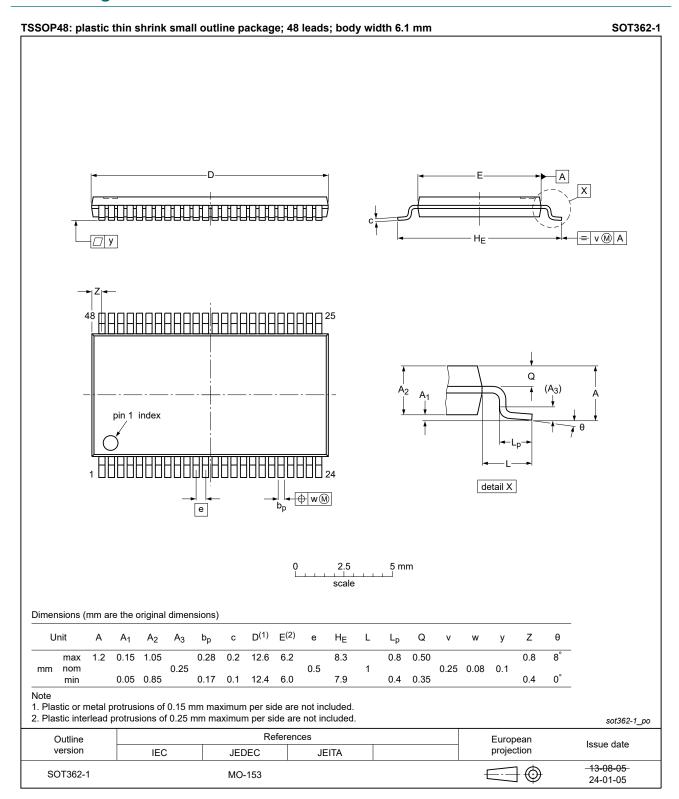


Fig. 7. Package outline SOT362-1 (TSSOP48)

TVSOP48: plastic thin shrink small outline package; 48 leads; body width 4.4 mm; lead pitch 0.4 mm

SOT480-1

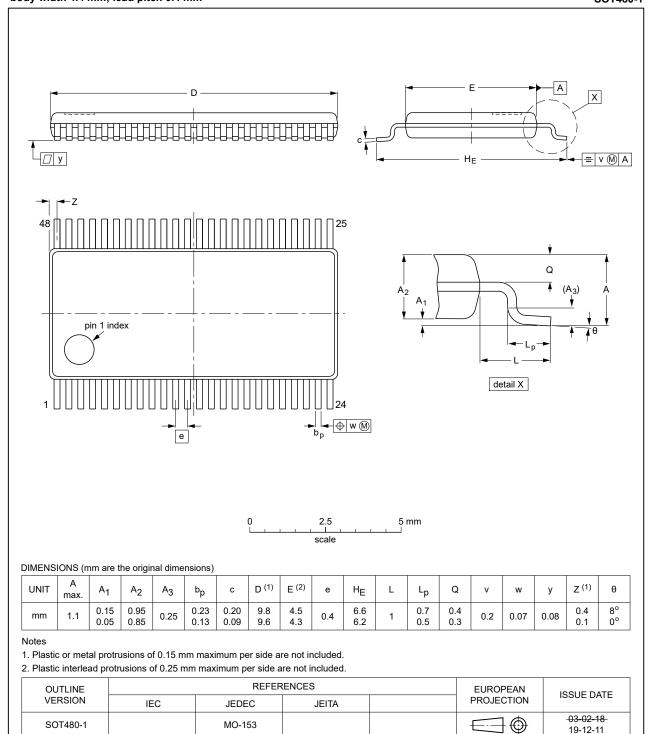


Fig. 8. Package outline SOT480-1 (TVSOP48)

## 12. Abbreviations

#### **Table 10. Abbreviations**

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
TTL	Transistor-Transistor Logic

# 13. Revision history

#### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
74LVC_LVCH16244A_Q100 v.8	20240409	Product data sheet	-	74LVC_LVCH16244A_Q100 v.7			
Modifications:	• Fig. 7: Updat	Fig. 7: Updated package outline drawing SOT362-1 (TSSOP48).					
74LVC_LVCH16244A_Q100 v.7	20230801	Product data sheet	-	74LVC_LVCH16244A_Q100 v.6			
Modifications:	Section 2: Es	SD specification updat	ed according to th	ne latest JEDEC standard.			
74LVC_LVCH16244A_Q100 v.6	20210921	Product data sheet	-	74LVC_LVCH16244A_Q100 v.5			
Modifications:	Section 1 and	d <u>Section 2</u> updated.					
74LVC_LVCH16244A_Q100 v.5	20190215	Product data sheet	-	74LVC_LVCH16244A_Q100 v.4			
Modifications:	Type number added.	rs 74LVC16244ADGV-	-Q100 and 74LVC	CH16244ADGV-Q100 (SOT480-1)			
74LVC_LVCH16244A_Q100 v.4	20170616	Product data sheet	-	74LVC_LVCH16244A_Q100 v.3			
Modifications:	guidelines of	Nexperia. ave been adapted to t	· ·	o comply with the identity name where appropriate.			
74LVC_LVCH16244A_Q100 v.3	20140207	Product data sheet	-	74LVC_LVCH16244A_Q100 v.2			
Modifications:	• <u>Table 5</u> : Mini	mum V <sub>CC</sub> changed fro	m 2.3 V to 1.65 V	(errata).			
74LVC_LVCH16244A_Q100 v.2	20130927	Product data sheet	-	74LVC_LVCH16244A_Q100 v.1			
Modifications:	Typo remove	ed from the title header					
74LVC_LVCH16244A_Q100 v.1	20130923	Product data sheet	-	-			

## 14. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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